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Enhance Europe to play a vital role in the semiconductor industry through Semiconductor-X, design capabilities and expansion of the Eco-System

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Germany – Change process starts

Germany under pressure	Missing value chain o Digital Leading Edge Semiconductors
USA & China digitize Germany	US – China trade confli

Sovereignty is key for Germany and Europe

¹ <u>Horizon Grand View Research - Europe High Performance Computing Market Size & Outlook</u> ² Kearney – Europe's urgent need to invest in a leading-edge semiconductor ecosystem 15%/Year

yearly growth of Leading Edge semiconductors in Europe¹

43%

Leading Edge semiconductors of all chips in Europe by 2030²

€34 Mrd.

Revenue for Leading Edge semiconductors in the EU by 2030²

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Status Quo of Semiconductor value chain in Europe



Contribution to the semiconductor value chain by country/region.

Source: Strategy& - "Forging Germany's digital destiny: The imperative of a sustainable microelectronics strategy", 2023

Research

- Chip design
- European R&D spending
 fragmented and lower than in other regions
 - (In spite of strong EU research environment)

Strong focus on

- the US (& Asia)
- Europe lacks leading-edge design skills

Production

- Only 3 leading-edge companies worldwide: TSMC (TWN), Samsung (KOR) and Intel (US)
- Apart from Intel (Ireland i3),
 Europe does not have a leadedge production to date

Applications

- The US led the way in the development of leading-edge applications, e.g.
 AI and self-driving cars
- China racing to catch up

What is Digital Leading-edge? It is the driving force in the semiconductor industry



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Why digital leading edge

From FinFET to GAA (Gate-All-Around): Revolutionizing Semiconductor Efficiency and Performance, just as Smartphones transformed Communication



Embrace the Future with GAA Technology



Practical examples

Maximizing Value for different industries through Leading Edge Technology

Automotive:

ADAS needs high computational power for real-time processing, Software Defined Vehicle as well as enhance industry production

Telco:

5G and future 6G development require high-speed, lowlatency processing

Defense:

Defense and aerospace applications need advanced computational capabilities for real-time analysis

Healthcare:

Genomics demand top performance and efficiency from applications.

HPC:

HPC needs high energy efficiency to manage best performance with optimized TCO, e.g. climate models

Status Quo of Semiconductor value chain in Europe

How to address the situation in Europe



Design Enablement Teams (DET)

Step 2 (optional)

Offering the opportunity to create a leading-edge design hub in Bavaria

Step 3

EU Design Platform Platform Competence Chip Design Hubs User Coordination Centers Accelerator Team EDA DET 1 User Training Selection < > OVH IaC IP Refer user to User CDA DET 2 Foundries Need analysis Framework Azure Agreements User **Pilot lines** DET 3 **On-boarding** Requirements & AWS Cloud Standards User DET X ණ Assign function via voucher-system

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User

Step 1

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Step 4

Leading-edge design hub (e.g., Intel 18A)

Licences

Manufacturing-X Drives Digitalization Across the Manufacturing Industries

Semiconductor-X is a specialized initiative for the semiconductor industry





Semiconductor-X

Project Team

Partners across Industrial Supply Chain and RnD Organizations:



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Semiconductor-X Objectives of the overall project and priorities

"Building a sovereign data ecosystem and digital twin for the national and international Semiconductor industry to create a resilient value chain"



Summary

Europe needs to secure semiconductor supply,

50% of the value-added for a semiconductor product is in the design *

with an increasing relevance of digital leading edge technologies for AI

*BCG and SIA, 2021: https://www.semiconductors.org/wp-content/uploads/2021/05/BCG-x-SIA-Strengthening-the-Global-Semiconductor-Value-Chain-April-2021_1.pdf

